

ABSTRACT

The invention provides a resin composition for cleaning a die, including an ethylene-propylene rubber (A), a butadiene rubber (B), an inorganic filler (C), and a urea derivative (D). A mass ratio of a content of a constitutional unit originating from ethylene to a content of a constitutional unit originating from propylene in the ethylene-propylene rubber (A) is in a range of from 55/45 to 60/40, and a mass ratio (A/B) of a content of the ethylene-propylene rubber (A) to a content of the butadiene rubber (B) is in a range of from 30/70 to 70/30.